# MF0ICU2

## MIFARE Ultralight C - Contactless ticket IC

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Product data sheet COMPANY PUBLIC

## 1 General description

NXP Semiconductors has developed the MIFARE Ultralight C - Contactless ticket IC MF0ICU2 to be used in a contactless smart ticket or smart card in combination with Proximity Coupling Devices (PCD). The communication layer (MIFARE RF Interface) complies to parts 2 and 3 of the ISO/IEC 14443 Type A standard (see Ref. 1 and Ref. 2).

The MF0ICU2 is primarily designed for limited use applications such as public transportation, event ticketing and loyalty applications.

### 1.1 Contactless energy and data transfer

In the MIFARE system, the MF0ICU2 is connected to a coil with a few turns. The MF0ICU2 fits for the TFC.0 (Edmonson) and TFC.1 ticket formats as defined in EN 753-2.

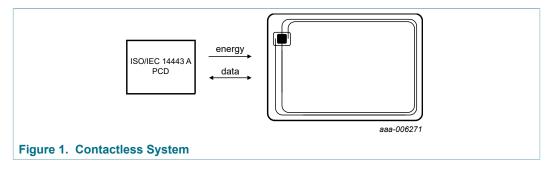
TFC.1 ticket formats are supported by the MF0xxU20 chip featuring an on-chip resonance capacitor of 16 pF.

The smaller TFC.0 tickets are supported by the MFxxU21 chip holding an on-chip resonance capacitor of 50 pF.

When the ticket is positioned in the proximity of the coupling device (PCD) antenna, the high speed RF communication interface allows the transmission of the data with a baud rate of 106 kbit/s.

#### 1.2 Anticollision

An intelligent anticollision function allows to operate more than one card in the field simultaneously. The anticollision algorithm selects each card individually and ensures that the execution of a transaction with a selected card is performed correctly without interference from another card in the field.



The anticollision function is based on an IC individual serial number called Unique IDentification. The UID of the MF0ICU2 is 7 bytes long and supports cascade level 2 according to ISO/IEC 14443-3.



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## 1.3 Security

- 3DES Authentication
- Anti-cloning support by unique 7-byte serial number for each device
- 32-bit user programmable OTP area
- Field programmable read-only locking function per page for first 512-bit
- · Read-only locking per block for the memory above 512 bit

### 1.4 Naming conventions

**Table 1. Naming conventions** 

MF0xxU2w01Dyy	Description			
MF	MIFARE family			
0	Ultralight product family			
xx	Two character identifier for the package type IC bare die MO contactless module			
U2	Product: Ultralight C			
W	One character identifier for input capacitance 0 16 pF 1 50 pF			
01D	Fixed			
уу	This is a two character identifier for the package type UF bare die, 75 µm thickness UD bare die, 120 µm thickness A4 MOA4 contactless module A8 MOA8 contactless module			

#### 2 **Features and benefits**

### 2.1 MIFARE RF Interface (ISO/IEC 14443 A)

- · Contactless transmission of data and supply energy
- configuration

· Operating distance up to 100 mm

depending on antenna geometry and reader

- Operating frequency of 13.56 MHz
- Data transfer of 106 kbit/s
- Data integrity of 16-bit CRC, parity, bit coding, True anticollision bit counting
- 7 byte serial number (cascade level 2 according to ISO/IEC 14443-3)
- Typical ticketing transaction: < 35 ms
- Fast counter transaction: < 10 ms

#### 2.2 EEPROM

1536-bit total memory

• 512-bit compatible to MF0ICU1

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- 36 pages, 1152-bit user r/w area
- Field programmable read-only locking function per page for first 512-bit
- 32-bit user definable One-Time Programmable (OTP) area
- Data retention of 10 years

- Field programmable read-only locking function per block
- 16-bit one-way counter
- Write endurance 100000 cycles

## 3 Quick reference data

Table 2. Characteristics

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f <sub>i</sub>	input frequency			-	13.56	-	MHz
C <sub>i</sub>	input capacitance	16 pF version (bare silicon and MOA4)	[1]	14.08	16	17.92	pF
		50 pF version	[1]	44	50	56	pF
EEPROM	characteristics						
t <sub>cy(W)</sub>	write cycle time			-	4.1	-	ms
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C		10	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C		100000	-	-	cycle

<sup>[1]</sup>  $T_{amb} = 22 \, ^{\circ}C$ , f = 13.56 MHz,  $V_{LaLb} = 1.5 \, V$  RMS

# 4 Ordering information

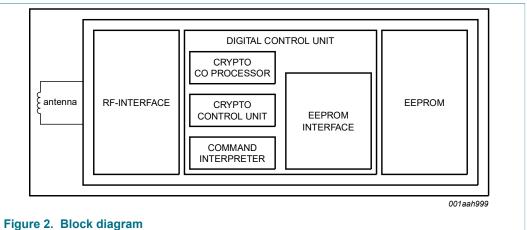
Table 3. Ordering information

Type number	Package		
	Name	Description	Version
MF0ICU2001DUF	-	8 inch wafer (laser diced; 75 µm thickness, on film frame carrier; electronic fail die marking according to SECSII format); 16 pF input capacitance	-
MF0ICU2101DUF	-	8 inch wafer (laser diced; 75 µm thickness, on film frame carrier; electronic fail die marking according to SECSII format), 50pF input capacitance	-
MF0ICU2001DUD	-	8 inch wafer (laser diced; 120 μm thickness, on film frame carrier; electronic fail die marking according to SECSII format); 16 pF input capacitance	-
MF0ICU2101DUD	-	8 inch wafer (laser diced; 120 μm thickness, on film frame carrier; electronic fail die marking according to SECSII format), 50pF input capacitance	-
MF0MOU2001DA4	PLLMC	MOA4 plastic leadless module carrier package; 35 mm wide tape; 16 pF input capacitance	SOT500-2
MF0MOU2101DA4	PLLMC	MOA4 plastic leadless module carrier package; 35 mm wide tape; 50 pF input capacitance	SOT500-2
MF0MOU2001DA8	PLLMC	MOA8 plastic leadless module carrier package; 35 mm wide tape; 16 pF input capacitance	SOT500-4

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Type number	Package		
	Name	Description	Version
MF0MOU2101DA8	PLLMC	MOA8 plastic leadless module carrier package; 35 mm wide tape; 50 pF input capacitance	SOT500-4

# **Block diagram**



# **Pinning information**

#### **Smart card contactless module**

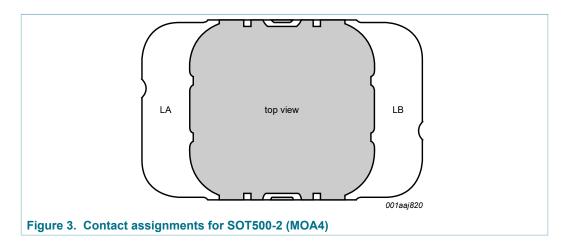


Table 4. Pin allocation table

Antenna contacts	Symbol	Description
LA	LA	Antenna coil connection LA
LB	LB	Antenna coil connection LB

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## 7 Functional description

## 7.1 Block description

The MF0ICU2 chip consists of a 1536-bit EEPROM, an RF-Interface and the Digital Control Unit. Energy and data are transferred via an antenna, which consists of a coil with a few turns directly connected to the MF0ICU2. No further external components are necessary. For details on antenna design please refer to the document Ref. 7.

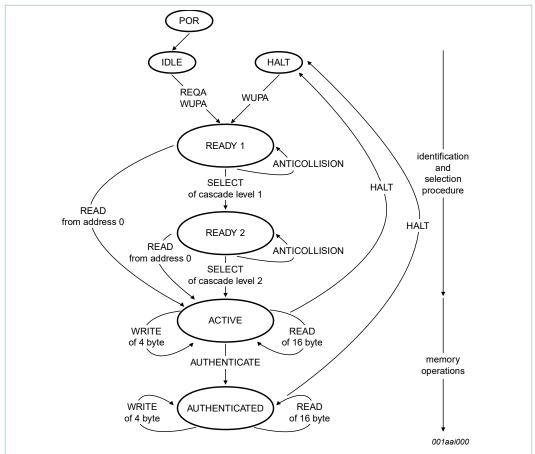
- RF-Interface:
  - Modulator/Demodulator
  - Rectifier
  - Clock Regenerator
  - Power On Reset
  - Voltage Regulator
- Crypto coprocessor: Triple Data Encryption Standard (3DES) coprocessor
- Crypto control unit: controls Crypto coprocessor operations
- Command Interpreter: Handles the commands supported by the MF0ICU2 in order to access the memory
- EEPROM-Interface
- EEPROM: The 1536 bits are organized in 48 pages with 32 bits each. 80 bits are reserved for manufacturer data. 32 bits are used for the read-only locking mechanism.
   32 bits are available as OTP area. 1152 bits are user programmable read/write memory.

### 7.2 State diagram and logical states description

The commands are initiated by the PCD and controlled by the Command Interpreter of the MF0ICU2. It handles the internal states (as shown in <u>Figure 4</u>) and generates the appropriate response.

For a correct implementation of an anticollision procedure please refer to the documents in <u>Section 14</u>.

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**Remark:** In each state the command interpreter returns to the Idle state if an unexpected command is received or any other error occurs. If the IC has already been in the Halt state before it returns to the Halt state in such a case. Those transitions are not explicitly shown in the state diagram.

Figure 4. State diagram

#### 7.2.1 IDLE

After Power On Reset (POR) the MF0ICU2 enters IDLE state. With a REQA or a WUPA command sent from the PCD transits to the READY1 state. Any other data received in this state is interpreted as an error and the MF0ICU2 remains waiting in the Idle state.

Please refer to Ref. 4 for implementation hints for a card polling algorithm that respects relevant timing specifications from ISO/IEC 14443 Type A.

After a correctly executed HLTA command i.e. out of the ACTIVE or AUTHENTICATED state, the default waiting state changes from the IDLE state to the HALT state. This state can then be exited with a WUPA command only.

#### 7.2.2 READY1

In the READY1 state the MF0ICU2 supports the PCD in resolving the first part of its UID (3 bytes) with the ANTICOLLISION or a cascade level 1 SELECT command.

There are two possibilities to leave this state:

MF0ICU2

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- With the cascade level 1 SELECT command the PCD transits the MF0ICU2 into the READY2 state where the second part of the UID can be resolved
- With the READ (from page address 00h) command the complete anticollision mechanism may be skipped and the MF0ICU2 changes directly into the ACTIVE state

**Remark:** If more than one MF0ICU2 is in the field of the PCD, a read from address 0 will cause a collision because of the different serial numbers, but all MF0ICU2 devices will be selected.

**Remark:** Any other data received in state READY1 state is interpreted as an error and the MF0ICU2 falls back to its waiting state (IDLE or HALT, depending on its previous state).

The response of the MF0ICU2 to the cascade level 1 SELECT command is the SAK byte with value 04h. It indicates that the UID has not been complete received by the PCD yet and another anticollision level is required.

#### 7.2.3 **READY2**

In the READY2 state the MF0ICU2 supports the PCD in resolving the second part of its UID (4 bytes) with the ANTICOLLISION command of cascade level 2. This state is left with the cascade level 2 SELECT command.

Alternatively, state READY2 state may be skipped via a READ (from block address 00h) command as described in state READY1.

**Remark:** If more than one MF0ICU2 is in the field of the PCD, a read from address 00h will cause a collision because of the different serial numbers, but all MF0ICU2 devices will be selected.

**Remark:** The response of the MF0ICU2 to the cascade level 2 SELECT command is the SAK byte with value 00h. According to ISO/IEC14443 this byte indicates whether the anticollision cascade procedure is finished (see Ref. 6). In addition it defines for the MIFARE architecture platform the type of the selected device. At this stage the MF0ICU2 is uniquely selected and only a single device will continue communication with the PCD even if other contactless devices are in the field of the PCD.

Any other command received in this state is interpreted as an error and the MF0ICU2 falls back to its waiting state (IDLE or HALT, depending on its previous state).

#### **7.2.4 ACTIVE**

In the ACTIVE state READ (16 bytes), WRITE (4 bytes), COMPATIBILITY WRITE (16 bytes) commands or an authentication can be performed.

After a successful authentication the state "AUTHENTICATED" is reached, see <u>Section</u> 7.2.6.

The ACTIVE state is gratefully exited with the HLTA command and upon reception the MF0ICU2 transits to the HALT state.

Any other command received in this state is interpreted as an error and the MF0ICU2 goes back to its waiting state (IDLE or HALT, depending on its previous state).

#### 7.2.5 HALT

Besides the IDLE state the HALT state constitutes the second waiting state implemented in the MF0ICU2. A MF0ICU2 that has already been processed can be set into this

MF0ICU2

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state via the HLTA command. This state helps the PCD to distinguish between already processed cards and cards that have not been selected yet. The only way to get the MF0ICU2 out of this state is the WUPA command or a RF reset. Any other data received in this state is interpreted as an error and the MF0ICU2 remains in this state.

#### 7.2.6 AUTHENTICATED

In the AUTHENTICATED state either a READ or a WRITE command may be performed to memory areas, which are only readable and/or writeable after authentication.

Authentication is performed using the 3DES Authentication described in Section 7.5.5.

#### 7.3 Data integrity

The following mechanisms are implemented in the contactless communication link between PCD and MF0ICU2 to ensure a reliable data transmission:

- 16 bits CRC per block
- · Parity bit for each byte
- · Bit count checking
- Bit coding to distinguish between "1", "0", and no information
- Channel monitoring (protocol sequence and bit stream analysis)

#### 7.4 RF interface

The RF-interface is implemented according to the standard for contactless smart cards ISO/IEC 14443 Type A (see Ref. 1 and Ref. 2).

The RF-field from the PCD is always present (with short modulation pulses when transmitting), because it is used for the power supply of the card.

For both directions of data communication there is one start bit at the beginning of each frame. Each byte is transmitted with a parity bit (odd parity) at the end. The LSBit of the byte with the lowest byte address within selected page is transmitted first. The maximum frame length is 164 bits (16 data bytes + 2 CRC bytes = 16 \* 9 + 2 \* 9 + 1 start bit + 1 end bit).

#### 7.5 Memory organization

The 1536-bit EEPROM memory is organized in 48 pages with 32 bits each. In the erased state the EEPROM cells are read as a logical "0", in the written state as a logical "1".

Table 5. Memory organization

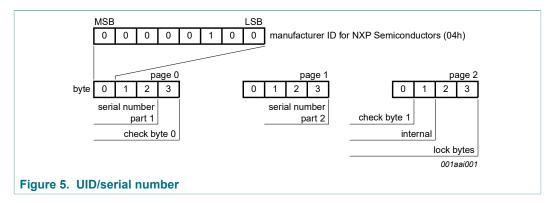
Page address		Byte number			
Decimal	Hex	0	1	2	3
0	00h		serial r	number	
1	01h	serial number			
2	02h	serial number	internal	lock bytes	lock bytes
3	03h	OTP	OTP	OTP	OTP
4 to 39	04h to 27h	user memory	user memory	user memory	user memory
40	28h	lock bytes	lock bytes	-	-

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Page address		Byte number			
Decimal	Hex	0	1	2	3
41	29h	16-bit counter	16-bit counter	-	-
42	2Ah	authentication configuration			
43	2Bh	authentication configuration			
44 to 47	2Ch to 2Fh	authentication key			

#### 7.5.1 UID/serial number

The unique 7 byte serial number (UID) and its two Block Check Character Bytes (BCC) are programmed into the first 9 bytes of the memory. It therefore covers page 00h, page 01h and the first byte of page 02h. The second byte of page 02h is reserved for internal data. Due to security and system requirements these bytes are programmed and write-protected in the production test.



SN0 holds the Manufacturer ID for NXP (04h) according to ISO/IEC14443-3 and ISO/IEC 7816-6 AMD.1.

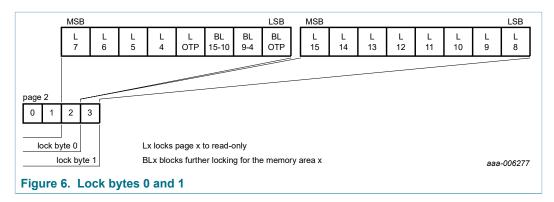
According to ISO/IEC14443-3 BCC0 is defined as CT  $\oplus$  SN0  $\oplus$  SN1  $\oplus$  SN2. Abbreviations CT stays for Cascade Tag byte (88h) and BCC1 is defined as SN3  $\oplus$  SN4  $\oplus$  SN5  $\oplus$  SN6.

#### 7.5.2 Lock byte 0 and 1

The bits of byte 2 and byte 3 of page 02h represent the field programmable permanent read-only locking mechanism. Each page from 03h (OTP) to 0Fh can be individually locked by setting the corresponding locking bit Lx to logic 1 to prevent further write access. After locking, the corresponding page becomes read-only memory. To restrict read access to the memory refer to the authentication functionality (see Section 7.5.5).

The three least significant bits of lock byte 0 are the block-locking bits. Bit 2 deals with pages 0Ah to 0Fh, bit 1 deals with pages 04h to 09h and bit 0 deals with page 03h (OTP). Once the block-locking bits are set, the locking configuration for the corresponding memory area is frozen. The functionality of the bits inside the lock bytes 0 and 1 are shown in Table 6.

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For example if BL15-10 is set to logic 1, then bits L15 to L10 (lock byte 1, bit[7:2]) can no longer be changed. A WRITE command or COMPATIBILITY\_WRITE command to page 02h, sets the locking and block-locking bits. Byte 2 and byte 3 of the WRITE or COMPATIBILITY\_WRITE command, and the contents of the lock bytes are bit-wise OR'ed and the result then becomes the new content of the lock bytes. This process is irreversible. If a bit is set to logic 1, it cannot be changed back to logic 0. Therefore, before writing the lock bytes, the user has to ensure that the corresponding user memory area and/or configuration bytes to be locked are correctly written.

The contents of bytes 0 and 1 of page 02h are unaffected by the corresponding data bytes of the WRITE (see <u>Section 9.3</u>) or COMPATIBILITY\_WRITE (see <u>Section 9.4</u>) command.

The default value of the static lock bytes is 00 00h.

For compatibility reasons, the first 512 bits of the memory area have the same functionality as the MIFARE Ultralight MF0ICU1 (see also Ref. 8), meaning that the two lock bytes used for the configuration of this memory area have identical functionality. The mapping of single lock bits to memory area for the first 512 bits is shown in Figure 6 and Table 6.

Table 6. Functionality of lock bits in lock byte 0 and 1

Lock Byte	Bit	Function	Block Locking in Lock Byte	Block Locking in Bit
0	3	lock OTP page	0	0
0	4	lock page 4	0	1
0	5	lock page 5	0	1
0	6	lock page 6	0	1
0	7	lock page 7	0	1
1	0	lock page 8	0	1
1	1	lock page 9	0	1
1	2	lock page 10	0	2
1	3	lock page 11	0	2
1	4	lock page 12	0	2
1	5	lock page 13	0	2
1	6	lock page 14	0	2
1	7	lock page 15	0	2

MF0ICU2

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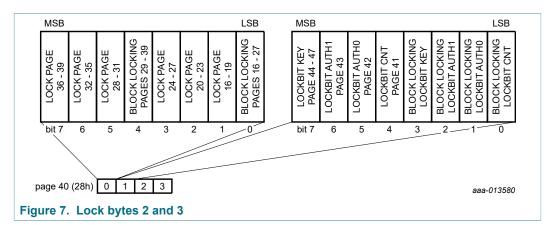
Any write operation to the lock bytes 0 and 1, features anti-tearing support.

**Remark:** The configuration written in the lock bytes is valid upon the next REQA or WUPA command.

#### 7.5.3 Lock byte 2 and 3

To lock the pages of the MF0UL21 starting at page address 10h onwards, the lock bytes 2 and 3 located in page 28h (byte 0 and 1 as shown in Figure 7) are used. Those two lock bytes cover the memory area of 96 data bytes in pages 10h (16d) to 27h (39d) and the configuration area from page address 28h onwards. The granularity is 4 pages, compared to a single page for the first 512 bits as shown in Figure 7. The functionality of the bits inside the lock bytes 2 and 3 are shown in Table 7.

Remark: Set all bits marked with RFUI to 0, when writing to the lock bytes.



The default value of lock bytes 2 and 3 is 00 00h. The value of byte 3 on page 28h (see Figure 7) is always BDh when read.

The contents of bytes 2 and 3 of page 28h are unaffected by the corresponding data bytes of the WRITE (see <u>Section 9.3</u>) or COMPATIBILITY\_WRITE (see <u>Section 9.4</u>) command.

Table 7. Functionality of lock bits in lock byte 2 and 3

Lock Byte	Bit	Function	Block Locking in Lock Byte	Block Locking in Bit
2	1	lock page 16-19	2	0
2	2	lock page 20-23	2	0
2	3	lock page 24-27	2	0
2	5	lock page 28-31	2	4
2	6	lock page 32-35	2	4
2	7	lock page 36-39	2	4
3	4	lock Counter	3	0
3	5	lock AUTH0	3	1
3	6	lock AUTH1	3	2
3	7	lock Key	3	3

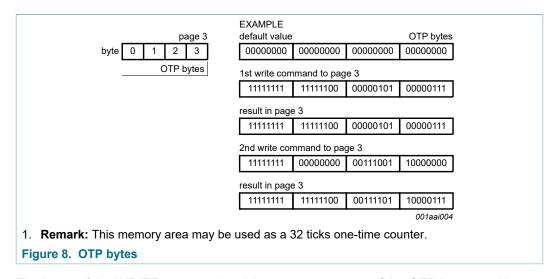
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Any write operation to the lock bytes 2 and 3, features anti-tearing support.

**Remark:** The configuration written in the lock bytes is valid upon the next REQA or WUPA command.

#### 7.5.4 OTP bytes

Page 3 is the OTP page. It is preset to all "0" after production. These bytes may be bitwise modified by the WRITE or COMPATIBILITY WRITE command.



The bytes of the WRITE command and the current contents of the OTP bytes are bitwise "OR-ed" and the result forms the new content of the OTP bytes. This process is irreversible. If a bit is set to "1", it cannot be changed back to "0" again.

The default value of the OTP bytes is 00 00 00 00h.

Any write operation to the OTP bytes features anti-tearing support.

#### 7.5.5 3DES Authentication

The 3DES Authentication implemented in the MF0ICU2 proves that two entities hold the same secret and each entity can be seen as a reliable partner for onwards communication. The applied encryption algorithm ek() is the 2 key 3DES encryption (see Ref. 9) in Cipher-Block Chaining (CBC) mode as described in ISO/IEC 10116 (see Ref. 10). The Initial Value (IV) of the first encryption of the protocol is the all zero block. For the subsequent encryptions the IV consists of the last ciphertext block.

The following table shows the communication flow during authentication:

Table 8. 3DES authentication

#	PCD	Data exchanged	PICC	
1	The reader device is always the entity which starts an authentication procedure. This is done by sending the command AUTHENTICATE.	"1Ah" → AUTHENTICATE		Step 1

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#	PCD	Data exchanged	PICC	
2		← "AFh"    8 bytes ek(RndB)	The PICC generates a 8 byte random number <i>RndB</i> . This random number is <b>en</b> ciphered with the key, denoted by <i>ek(RndB)</i> , and is then transmitted to the PCD.	
3	The PCD itself generates a 8 byte random number <i>RndA</i> . This <i>RndA</i> is concatenated with <i>RndB</i> ' and <b>en</b> ciphered with the key. <i>RndB</i> ' is generated by rotating the original <i>RndB</i> left by 8 bits. This token $ek(RndA    RndB')$ is sent to the PICC.	→ "AFh"    16 bytes ek(RndA    RndB')		
4			The PICC runs an <b>de</b> cipherment on the received token and thus gains <i>RndA</i> + <i>RndB</i> '. The PICC can now verify the sent <i>RndB</i> ' by comparing it with the <i>RndB</i> ' obtained by rotating the original <i>RndB</i> left by 8 bits internally.  A successful verification proves to the PICC that the PICC and the PCD posses the same secret key.  If the verification fails, the PICC stops the authentication procedure and returns an error message.  As the PICC also received the random number <i>RndA</i> , generated by the PCD, it can perform a rotate left operation by 8 bits on <i>RndA</i> to gain <i>RndA</i> ', which is <b>en</b> ciphered again, resulting in <i>ek(RndA')</i> . This token is sent to the PCD.	Step 2
5	The PCD runs a <b>de</b> cipherment on the received <i>ek(RndA')</i> and thus gains <i>RndA'</i> for comparison with the PCD-internally rotated <i>RndA'</i> .  If the comparison fails, the PCD exits the procedure and may halt the PICC.			
6			The PICC sets the state to authenticate.	

The cryptographic method is based on 3DES in CBC mode.

See command details in <u>Section 9.5</u>. The used key is a double length DES Key; where the parity bits are not checked or used.

## 7.5.6 3DES Authentication example

A numerical example of a 3DES authentication process is shown below in <u>Table 9</u>. The key used in the example has a value of 49454D4B41455242214E4143554F5946h.

Table 9. Numerical 3DES authentication example

#	PCD	Data exchanged	PICC
1	start the authentication procedure	$\rightarrow$	
		1Ah	

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#	PCD	Data exchanged	PICC
2		← AF577293FD2F34CA51	generate RndB = 51E764602678DF2B IV = 00000000000000000 ek(RndB) = 577293FD2F34CA51
3	decipher ek(RndB) to retrieve RndB generate RndA = A8AF3B256C75ED40 RndB' = E764602678DF2B51 RndA+RndB' = A8AF3B256C75ED40E764602678DF2B51 IV = 577293FD2F34CA51 ek(RndA+RndB') = 0A638559FC7737F9F15D7862EBBE967A	→ AF0A638559FC7737F9 F15D7862EBBE967A	
4		← 003B884FA07C137CE1	decipher ek(RndA+RndB') to retrieve RndA verify RndB' RndA'=AF3B256C75ED40A8 IV = F15D7862EBBE967A ek(RndA')= 3B884FA07C137CE1
5	decipher and verify ek(RndA')		

### 7.5.7 Programming of 3DES key to memory

The 16 bytes of the 3DES key are programmed to memory pages from 2Ch to 2Fh. The keys are stored in memory as shown in  $\underline{\text{Table 10}}$ . The key itself can be written during personalization or at any later stage using the WRITE (see  $\underline{\text{Section 9.3}}$ ) or COMPATIBILITY WRITE (see  $\underline{\text{Section 9.4}}$ ) command. For both commands, Byte 0 is always sent first.

Table 10. Key memory configuration

Byte address		0h	1h	2h	3h
Page address		Byte 0	Byte 1	Byte 2	Byte 3
2Ch	Page 44	Key1 / K0	Key1 / K1	Key1 / K2	Key1 / K3
2Dh	Page 45	Key1 / K4	Key1 / K5	Key1 / K6	Key1 / K7
2Eh	Page 46	Key2 / K0	Key2 / K1	Key2 / K2	Key2 / K3
2Fh	Page 47	Key2 / K4	Key2 / K5	Key2 / K6	Key2 / K7

On example of Key1 = 0001020304050607h and Key2 = 08090A0B0C0D0E0Fh, the command sequence needed for key programming with WRITE command is:

- A2 2C 07 06 05 04 CRC
- A2 2D 03 02 01 00 CRC
- A2 2E 0F 0E 0D 0C CRC
- A2 2F 0B 0A 09 08 CRC

The memory content after those (COMPATIBILITY) WRITE commands is shown in <u>Table</u> 11.

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Table 11. Memory content based on example configuration

Byte address		0h	1h	2h	3h
Page address		Byte 0	Byte 1	Byte 2	Byte 3
2Ch	Page 44	07	06	05	04
2Dh	Page 45	03	02	01	00
2Eh	Page 46	0F	0E	0D	0C
2Fh	Page 47	0B	0A	09	08

The memory pages holding the authentication key can never be read, independent of the configuration.

**Remark:** A re-programmed authentication key is only valid for authentication after a RF reset or a re-activation.

#### 7.5.8 Configuration for memory access via 3DES Authentication

The behavior of the memory access rights depending on the authentication is configured with two configuration bytes, AUTH0 and AUTH1, located in pages 2Ah and 2Bh. Both configuration bytes are located in Byte 0 of the respective pages (see also <u>Table 5</u>).

- AUTH0 defines the page address from which the authentication is required. Valid address values for byte AUTH0 are from 03h to 30h.
- Setting AUTH0 to 30h effectively disables memory protection.
- AUTH1 determines if write access is restricted or both read and write access are restricted, see <u>Table 12</u>

Table 12. AUTH1 bit description

Bit	Value	Description
1 to 7	any	ignored
0 1 write access restricted, re-		write access restricted, read access allowed without authentication
	0	read and write access restricted

### 7.5.9 Data pages

The MF0ICU2 features 144 bytes of data memory. The EEPROM memory is organized in pages with 4 bytes per page. The user memory area ranges from page 04h to 27h.

**Remark:** The default content of the user memory pages 04h to 27h at delivery is not defined.

A write access to data memory is done with a WRITE (see Section 9.3) or a COMPATIBILITY WRITE (see Section 9.4) command. In both cases, 4 bytes of memory - (one page) - will be written. Write access to data memory can be permanently restricted via lock bytes (see Section 7.5.2 and Section 7.5.3) and/or permanently or temporary restricted using an authentication (see Section 7.5.5).

Reading data is done using the READ command (see Section 9.2).

### 7.5.10 Initial memory configuration

The memory configuration of MF0ICU2 in delivery state is shown in <u>Table 13</u>:

#### MIFARE Ultralight C - Contactless ticket IC

Table 13. Initial memory organization

Page address		Byte number				
dec.	hex.	0	1	2	3	
0	00h	SN0	SN1	SN2	BCC0	
1	01h	SN3	SN4	SN5	SN6	
2	02h	BCC1	internal	00h	00h	
3	03h	00h	00h	00h	00h	
4 to 39	04h to 27h	not defined	not defined	not defined	not defined	
40	28h	00h	00h	rfu	rfu	
41	29h	00h	00h	rfu	rfu	
42	2Ah	30h	rfu	rfu	rfu	
43	2Bh	00h	rfu	rfu	rfu	
44	2Ch	42h	52h	45h	41h	
45	2Dh	4Bh	4Dh	45h	49h	
46	2Eh	46h	59h	4Fh	55h	
47	2Fh	43h	41h	4Eh	21h	

This configuration ensures that the complete memory area is available for personalization, without knowledge of the authentication key. All lock bytes are set to zero meaning that no page or functionality is locked. The Counter is set to zero.

**Remark:** It is strongly recommended to program the authentication key during personalization in a secure environment and configure the AUTH0 byte at least in a way that the key and the AUTH0 and AUTH1 bytes can only be overwritten with prior authentication. This can be achieved by setting AUTH0 to 2Ah.

#### 7.5.11 Counter

The MF0ICU2 features a 16-bit one-way counter, located at the first two bytes of page 29h. The default counter value is 0000h.

The first<sup>1</sup> valid WRITE or COMPATIBILITY WRITE to address 29h can be performed with any value in the range between 0001h and FFFFh and corresponds to the initial counter value. Every consecutive WRITE command, which represents the increment, can contain values between 0001h and 000Fh. Upon such WRITE command and following mandatory RF reset, the value written to the address 29h is added to the counter content.

After the initial write, only the lower nibble of the first data byte is used for the increment value (0h-Fh) and the remaining part of the data is ignored. Once the counter value reaches FFFFh and an increment is performed via a valid WRITE command, the MF0ICU2 will reply a NAK. If the sum of counter value and increment is higher than FFFFh, MF0ICU2 will reply a NAK and will not increment the counter.

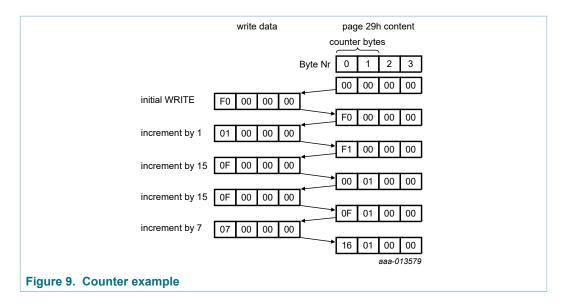
An increment by zero (0000h) is always possible, but does not have any impact to the counter value.

It is recommended to protect the access to the counter functionality by authentication.

An example for the counter functionality is shown in Figure 9.

<sup>1</sup> The first valid write is defined as a write to a counter value of 0000h with an argument different than zero

#### MIFARE Ultralight C - Contactless ticket IC



### 8 Command overview

The MIFARE Ultralight C card activation follows the ISO/IEC 14443 Type A. After the MIFARE Ultralight C card has been selected, it can either be deactivated using the ISO/IEC 14443 Halt command, or the MIFARE Ultralight C commands can be performed. For more details about the card activation refer to Ref. 2.

### 8.1 MIFARE Ultralight C command overview

All available commands for the MIFARE Ultralight C are shown in <u>Table 14</u>. All memory access commands are transmitted in plain, only the AUTHENTICATE command uses 3DES encryption, see <u>Section 9.5</u>.

Table 14. Command overview

Command	ISO/IEC 14443	Command code (hexadecimal)
Request	REQA	26h (7 bit)
Wake-up	WUPA	52h (7 bit)
Anticollision CL1	Anticollision CL1	93h 20h
Select CL1	Select CL1	93h 70h
Anticollision CL2	Anticollision CL2	95h 20h
Select CL2	Select CL2	95h 70h
Halt	Halt	50h 00h
READ	-	30h
WRITE	-	A2h
COMPATIBILITY WRITE	-	A0h
AUTHENTICATE	-	1Ah

All commands use the coding and framing as described in <u>Ref. 1</u> and <u>Ref. 2</u> if not otherwise specified.

#### MIFARE Ultralight C - Contactless ticket IC

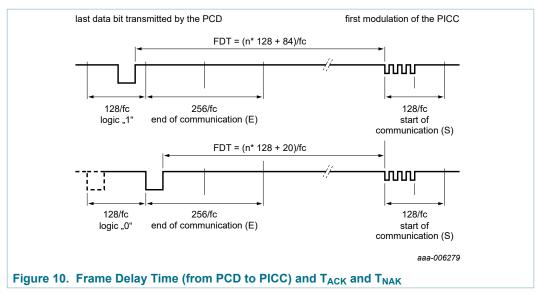
### 8.2 Timings

The timing shown in this document are not to scale and values are rounded to 1 µs.

All given command and response transmission times refer to the data frames including start of communication and end of communication. A PCD data frame contains the start of communication (1 "start bit") and the end of communication (one logic 0 + 1 bit length of unmodulated carrier). A PICC data frame contains the start of communication (1 "start bit") and the end of communication (1 bit length of no subcarrier).

The minimum command response time is specified according to  $\underline{\text{Ref. 2}}$  as an integer n which specifies the PCD to PICC frame delay time. The frame delay time (FDT) from PICC to PCD is at least 87  $\mu$ s which corresponds to a n=9. The maximum command response time is specified as a time-out value. Depending on the command, the  $T_{ACK}$  value specified for command responses defines the PCD to PICC frame delay time. It does it for either the 4-bit ACK/NAK value specified in Section 8.3 or for a data frame.

All command timings are according to ISO/IEC 14443-3 frame specification as shown for the Frame Delay Time in Figure 10. For more details refer to Ref. 1 and Ref. 2.



**Remark:** Due to the coding of commands, the measured timings usually excludes (a part of) the end of communication. Consider this factor when comparing the specified with the measured times.

#### 8.3 MIFARE Ultralight C ACK and NAK

The MIFARE Ultralight C - Contactless ticket IC uses, apart from the responses defined in the following sections, two half-byte answers to acknowledge the command received in ACTIVE and AUTHENTICATED state (see Figure 4) abbreviated as ACK and NAK.

The MIFARE Ultralight C - Contactless ticket IC distinguishes between positive (ACK) and negative (NAK) acknowledge. Valid values for ACK and NAK are shown in <u>Table 15</u>.

Table 15. ACK and NAK values

Answer value	Answer explanation
Ah	positive acknowledge (ACK)

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### MIFARE Ultralight C - Contactless ticket IC

Answer value	Answer explanation
2h	NAK for EEPROM write error
1h	NAK for parity or CRC error
Oh	NAK for any other error

After every NAK, the MF0ICU2 performs an internal reset and returns to IDLE or HALT state.

**Remark:** Any 4-bit response different from Ah shall be interpreted as NAK, although not all 4-bit values are detailed in <u>Table 15</u>

#### 8.4 Summary of device identification data

For more details on the values below please refer to Ref. 2, Ref. 3 and Ref. 4.

Table 16. Summary of relevant data for device identification

Code	Length	Value	<b>Binary Format</b>	Remark
ATQA	2 Byte	0044h	0000 0000 0100 0100	
СТ	1 Byte	88h	1000 1000	Cascade Tag, ensures collision with cascade level 1 products
SAK (casc. level 1)	1 Byte	04h	0000 0100	'1' indicates additional cascade level
SAK (casc. level 2)	1 Byte	00h	0000 0000	indicates complete UID and MIFARE Ultralight functionality
Manufacturer Byte	1 Byte	04h	0000 0100	indicates NXP Semiconductors as manufacturer

# 9 MIFARE Ultralight C - Contactless ticket IC commands

#### 9.1 MIFARE Ultralight C - Contactless ticket IC card activation

The ATQA and SAK values are identical as for MF0ICU1 (see Ref. 8). For information on ISO 14443 card activation, see Ref. 4. Summary of data relevant for device identification is given in Section 8.4.

#### **9.2 READ**

The READ command takes the page address as a parameter. Only addresses 00h to 2Bh are decoded. For higher addresses the MF0ICU2 returns a NAK. The MF0ICU2 responds to the READ command by sending 16 bytes starting from the page address defined in the command (e.g. if ADR is 03h, pages 03h, 04h, 05h, 06h are returned). The command structure is shown in Figure 11 and Table 17.

Table 18 shows the required timing.

#### MIFARE Ultralight C - Contactless ticket IC

A roll-over mechanism is implemented to continue reading from page 00h once the end of the accessible memory is reached. For example, reading from address 29h on a MF0ICU2 results in pages 29h, 2Ah, 2Bh and 00h being returned.

The following conditions apply if part of the memory is protected by the 3DES authentication for read access:

- if the MF0ICU2 is in the ACTIVE state
  - addressing a page which is equal or higher than AUTH0 results in a NAK response
  - addressing a page lower than AUTH0 results in data being returned with the roll-over mechanism occurring just before the AUTH0 defined page
- if the MF0ICU2 is in the AUTHENTICATED state
  - the READ command behaves like on a MF0ICU2 without access protection

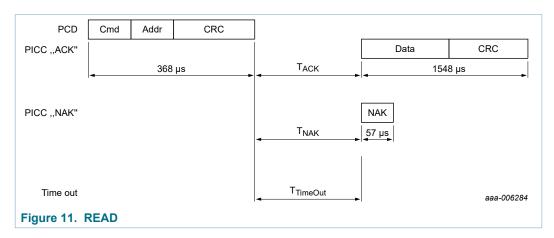


Table 17. READ command

Name	Code	Description	Length			
Cmd	30h	read four pages	1 byte			
Addr	-	start page address '00h' to '2Bh'	1 byte			
CRC	-	CRC according to Ref. 2	2 bytes			
Data	-	data content of the addressed pages	16 bytes			
NAK	see <u>Table 15</u>	see Section 8.3	4-bit			

### Table 18. READ timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
READ	n=9	T <sub>TimeOut</sub>	n=9	T <sub>TimeOut</sub>	5 ms

#### 9.3 WRITE

The WRITE command is used to program the lock bytes in page 02h, the OTP bytes in page 03h, data bytes in pages 04h to 27h, configuration data from page 28h to 2B and keys from page 2Ch to 2Fh. A WRITE command is performed page-wise, programming 4 bytes in a page.The WRITE command is shown in Figure 12 and Table 19.

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#### MIFARE Ultralight C - Contactless ticket IC

Table 20 shows the required timing.

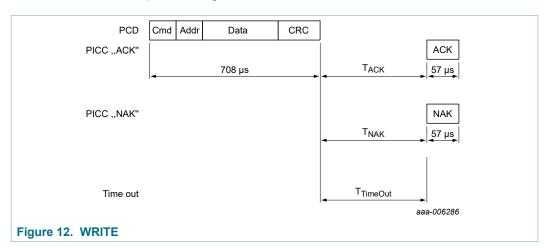


Table 19. WRITE command

Name	Code	Description	Length				
Cmd	A2h	write one page	1 byte				
Addr	-	page address '02h' to '2Fh'	1 byte				
CRC	-	CRC according to Ref. 2	2 bytes				
Data	-	data	4 bytes				
NAK	see <u>Table 15</u>	see Section 8.3	4-bit				

## Table 20. WRITE timing

These times exclude the end of communication of the PCD.

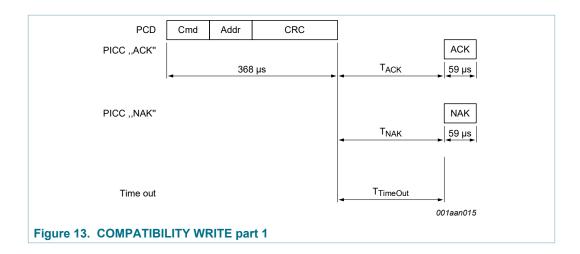
	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
WRITE	n=9	T <sub>TimeOut</sub>	n=9	T <sub>TimeOut</sub>	10 ms

#### 9.4 COMPATIBILITY WRITE

The COMPATIBILITY WRITE command was implemented to accommodate the established MIFARE PCD infrastructure. Even though 16 bytes are transferred to the MF0ICU2, only the least significant 4 bytes (bytes 0 to 3) will be written to the specified address. It is recommended to set the remaining bytes 4 to 15 to all '0'.

Personalization of authentication key: For writing the authentication key, one needs to write the key with four commands. The first command shall have the 4 least significant bytes of the key and shall be written on page 2Ch, the second 4 bytes shall be written on page 2Dh, the next 4 bytes shall be written on page 2Eh, the last 4 bytes shall be written on page 2Fh.

## MIFARE Ultralight C - Contactless ticket IC



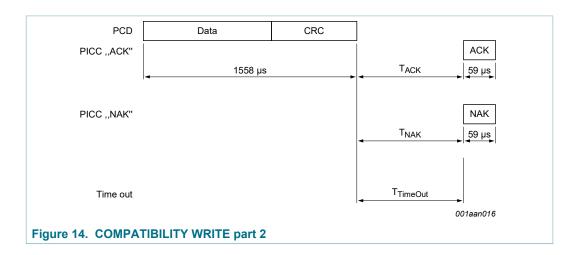


Table 21. COMPATIBILITY\_WRITE command

Name	Code	Description	Length
Cmd	A0h	compatibility write	1 byte
Addr	-	page address '02h' to '2Fh'	1 byte
CRC	-	CRC according to Ref. 2	2 bytes
Data	-	16-byte Data, only least significant 4 bytes are written	16 bytes
NAK	see <u>Table 15</u>	see Section 8.3	4-bit

#### Table 22. COMPATIBILITY\_WRITE timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
COMPATIBILITY_WRITE part 1	n=9	T <sub>TimeOut</sub>	n=9	$T_{TimeOut}$	5 ms
COMPATIBILITY_WRITE part 2	n=9	T <sub>TimeOut</sub>	n=9	$T_{TimeOut}$	10 ms

### MIFARE Ultralight C - Contactless ticket IC

### 9.5 AUTHENTICATE

**Description:** The authentication process is detailed <u>Section 7.5.5</u>.

The command is performed in the same protocol as READ, WRITE and COMPATIBILITY WRITE.

Executing a HALT command results in losing the authentication status.

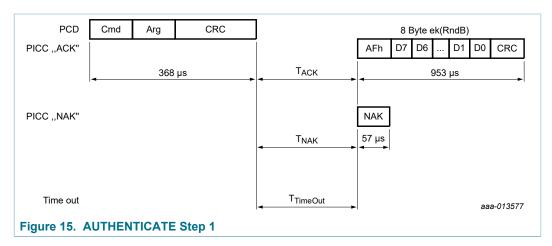


Table 23. AUTHENTICATE part 1 command

Name	Code	Description	Length
Cmd	1Ah	authentication part 1	1 byte
Arg	00h	fixed value 00h as argument	1 byte
CRC	-	CRC according to Ref. 2	2 bytes
AFh	AFh	first response byte indicates that the authentication process needs a second command part	
ek(RndB)	-	8-byte encrypted PICC random number RndB	8 bytes
NAK	see <u>Table 15</u>	see Section 8.3	4-bit

#### Table 24. AUTHENTICATE part 1 timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
AUTHENTICATE part 1	n=9	T <sub>TimeOut</sub>	n=9	$T_{TimeOut}$	5 ms

## Table 25. AUTHENTICATE Step 2

Code	Parameter	Data	Integrity mechanism	Response
AFh	-	ek(RndA+RndB')	Parity, CRC	'00' + ek(RndA')

### MIFARE Ultralight C - Contactless ticket IC

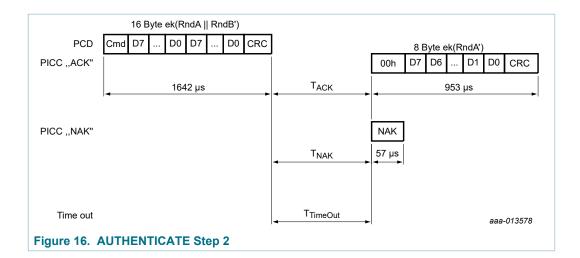


Table 26. AUTHENTICATE part 2 command

Name	Code	Description	Length
Cmd	AFh	fixed first byte for the AUTHENTICATE part 2 command	1 byte
ek(RndA    RndB')	-	16-byte encrypted random numbers RNDA concatenated by RndB'	16 bytes
CRC	-	CRC according to Ref. 2	2 bytes
00h	00h	first response byte indicates that the authentication process is finished after this command	1 bytes
ek(RndA')	-	8-byte encrypted, shifted PCD random number RndA'	8 bytes
NAK	see <u>Table 15</u>	see Section 8.3	4-bit

### Table 27. AUTHENTICATE part 2 timing

These times exclude the end of communication of the PCD.

	T <sub>ACK</sub> min	T <sub>ACK</sub> max	T <sub>NAK min</sub>	T <sub>NAK max</sub>	T <sub>TimeOut</sub>
AUTHENTICATE part 2	n=9	$T_{TimeOut}$	n=9	$T_{TimeOut}$	5 ms

# 10 Limiting values

Stresses exceeding one or more of the limiting values, can cause permanent damage to the device. Exposure to limiting values for extended periods can affect device reliability.

#### Table 28. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Min	Max	Unit
I <sub>I</sub>	input current	-	30	mA
T <sub>stg</sub>	storage temperature	-55	+125	°C

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## MIFARE Ultralight C - Contactless ticket IC

Symbol	Parameter		Min	Max	Unit
T <sub>amb</sub>	ambient temperature		-25	+70	°C
V <sub>ESD</sub>	electrostatic discharge voltage on LA/LB	[1]	2	-	kV

[1] ANSI/ESDA/JEDEC JS-001; Human body model: C = 100 pF, R = 1.5  $k\Omega$ 

#### **CAUTION**



This device has limited built-in ElectroStatic Discharge (ESD) protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the gates.

## 11 Characteristics

#### 11.1 Electrical characteristics

**Table 29. Characteristics** 

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
f <sub>i</sub>	input frequency			-	13.56	-	MHz
C <sub>i</sub>	input capacitance	16 pF version (bare silicon and MOA4)	[1]	14.08	16	17.92	pF
		50 pF version	[1]	44	50	56	pF
EEPROM o	haracteristics						
t <sub>cy(W)</sub>	write cycle time			-	4.1	-	ms
t <sub>ret</sub>	retention time	T <sub>amb</sub> = 22 °C		10	-	-	year
N <sub>endu(W)</sub>	write endurance	T <sub>amb</sub> = 22 °C		100000	-	-	cycle

<sup>[1]</sup>  $T_{amb}$  = 22 °C, f = 13.56 MHz,  $V_{LaLb}$  = 1.5 V RMS

# 12 Wafer specification

Table 30. Wafer specifications MF0ICU2x01DUy

Wafer	
diameter	200 mm typical (8 inches)
maximum diameter after foil expansion	210 mm
die separation process	laser dicing
thickness MF0ICU2x01XDUD	120 μm ± 15 μm
MF0ICU2x01XDUF	75 μm ± 10 μm
flatness	not applicable
Potential Good Dies per Wafer (PGDW)	61942
Wafer backside	
material	Si

## MIFARE Ultralight C - Contactless ticket IC

treatment	ground and stress relieve			
roughness	R <sub>a</sub> max = 0.2 μm			
	$R_t max = 2 \mu m$			
Chip dimensions				
step size <sup>[1]</sup>	x = 710 μm			
	y = 710 μm			
gap between chips <sup>[1]</sup>	typical = 22 μm			
	minimum = 5 μm			
Passivation				
type	sandwich structure			
material	PSG / nitride			
thickness	500 nm / 600 nm			
Au bump (substrate connected to VSS)				
material	> 99.9 % pure Au			
hardness	35 to 80 HV 0.005			
shear strength	> 70 MPa			
height	18 μm			
height uniformity	within a die = ±2 μm			
	within a wafer = ±3 μm			
	wafer to wafer = ±4 μm			
flatness	minimum = ±1.5 μm			
size	LA, LB, VSS, TP1, TP2 <sup>[2]</sup> = 60 μm × 60 μm			
size variation	±5 μm			
under bump metallization	sputtered TiW			

<sup>[1]</sup> The step size and the gap between chips may vary due to changing foil expansion [2] Pads VSS and TESTIO are disconnected when wafer is sawn.

#### 12.1 Fail die identification

Electronic wafer mapping covers the electrical test results and additionally the results of mechanical/visual inspection. No ink dots are applied.

## 12.2 Package outline

For more details on the contactless modules MOA4 and MOA8 please refer to Ref. 11 and Ref. 12.

## MIFARE Ultralight C - Contactless ticket IC

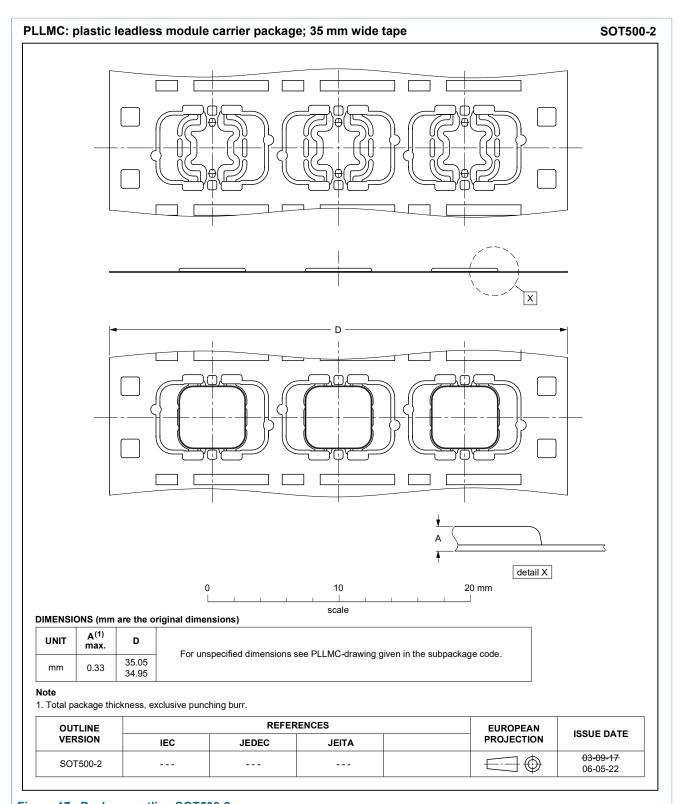
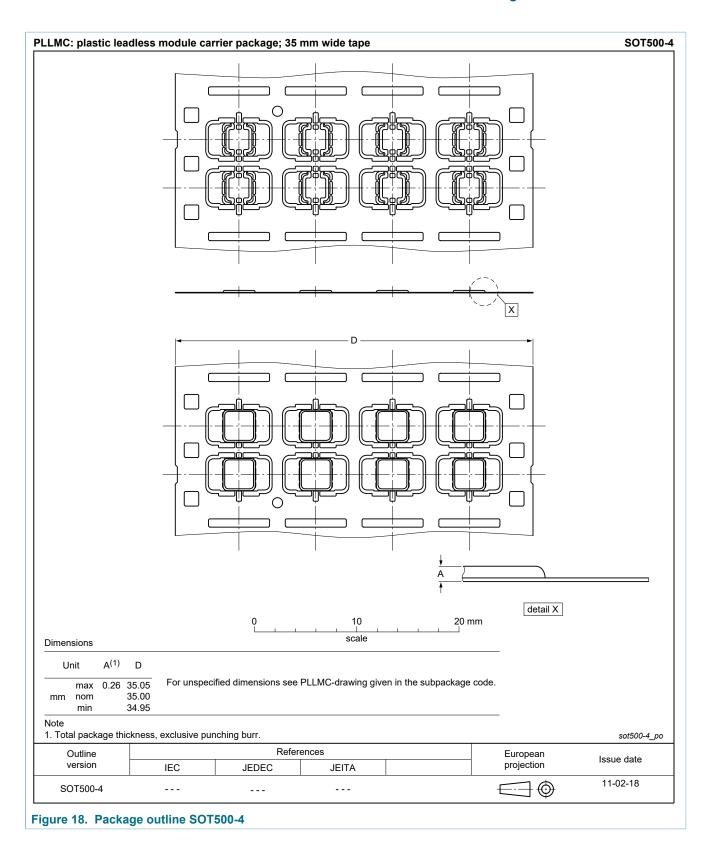


Figure 17. Package outline SOT500-2

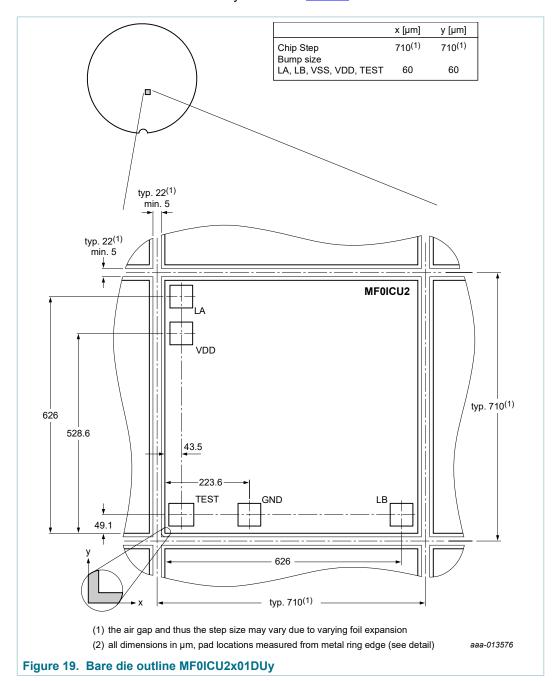
## MIFARE Ultralight C - Contactless ticket IC



## MIFARE Ultralight C - Contactless ticket IC

### 12.3 Bare die outline

For more details on the wafer delivery forms see Ref. 13.



## 13 Abbreviations

Table 31. Abbreviations

Acronym	Description
3DES	Triple Data Encryption Standard
ACK	Positive Acknowledge

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## MIFARE Ultralight C - Contactless ticket IC

Acronym	Description
ATQA	Answer To ReQuest, type A
BCC	Block Check Characters byte
CBC	Cipher-Block Chaining
CRC	Cyclic Redundancy Check
СТ	Cascade Tag, Type A
EEPROM	Electrically Erasable Programmable Read-Only Memory
fc	carrier frequency 13.56 MHz
HLTA	Halt A command
IV	Initial Value
LSB	Least Significant Bit
MSB	Most Significant Bit
NAK	Negative AcKnowledge
OTP	One Time Programmable
Passive ACK	Implicit acknowledge without PICC answer
PCD	Proximity Coupling Device
PICC	Proximity Integrated Circuit Card
POR	Power On Reset
REQA	ReQuest Answer, type A
RF	Radio Frequency
SAK	Select AcKnowledge, type A
UID	Unique Identifier
WUPA	Wake-UP command, type A

## 14 References

[1]

ISO/IEC 14443-2

2001

[2]

ISO/IEC 14443-3

2001

[3]

MIFARE Interface Platform Type Identification Procedure

Application note, BL-ID Doc. No.: 0184\*\*<sup>2</sup>

[4]

MIFARE ISO/IEC 14443 PICC Selection

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<sup>2 \*\* ...</sup> document version number

### MIFARE Ultralight C - Contactless ticket IC

Application note, BU S&C Doc. No.: 1308\*\*

[5]

MIFARE Ultralight Features and Hints

Application note, BU S&C Doc. No.: 0731\*\*

[6]

MIFARE Ultralight as Type 2 Tag

Application note, BU S&C Doc. No.: 1303\*\*

[7]

MIFARE (Card) Coil Design Guide

Application note, BU S&C Doc. No.: 0117\*\*

[8]

MF0ICU1 Functional specification MIFARE Ultralight

Product data sheet, BU S&C Doc. No. 0286\*\*

[9]

NIST SP800-67: Recommendation for the Triple Data Encryption Algorithm (TDEA) Block Cipher, Version 1.1 May 19, 2008

National Institute of Standards and Technology

[10]

ISO/IEC 10116: Information technology - Security techniques - Modes of operation for an n-bit block cipher, February 1, 2006

International Organization for Standardization

[11]

#### Contactless smart card module specification MOA4

Delivery Type Description, BU-ID Document number 0823\*\*2

[12]

#### Contactless smart card module specification MOA8

Delivery Type Description, BU-ID Document number 1636\*\*2

[13]

#### General specification for 8" wafer on UV-tape; delivery types

Delivery Type Description, BU-ID Document number 1005\*\*2

# MIFARE Ultralight C - Contactless ticket IC

# 15 Revision history

### Table 32. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
MF0ICU2 v. 3.3	20190730	Product data sheet	-	MF0ICU2 v. 3.2
Modifications:	<ul><li>Updated descriptive tex</li><li>Update of <u>Table 13</u></li></ul>	kt of the default user mer	nory content, Section 7.5.9	
MF0ICU2 v. 3.2	20140617	Product data sheet		137631
Modifications:	<ul> <li>Editorial changes</li> <li>Added 75 µm thin wafer and MOA8 delivery types</li> <li>New bare die outline drawing</li> <li>Corrected descriptive text in delivery forms for the 16 pF input capacitance</li> <li>Extended EEPROM specification with respect to programming cycle endurance and data retention</li> <li>New command descriptions including time-out specification</li> <li>Added descriptions for authentication, counter and lock bytes</li> <li>Removed ISO/IEC 14443-3 anticollision and selection commands and referred to standard</li> </ul>			
				nou to otanidard
137631	20090402	Product data sheet		137630
	20090402 • Section 16 "Legal information of the section 16"   Section 16			
Modifications:			-	
Modifications:	Section 16 "Legal information	mation": updated	-	137630
Modifications: 137630 Modifications:	Section 16 "Legal information 20090218	mation": updated	-	137630
137631 Modifications: 137630 Modifications: 137610 Modifications:	Section 16 "Legal information 20090218      General update	Product data sheet  Objective data sheet	-	137630 137610

#### MIFARE Ultralight C - Contactless ticket IC

# 16 Legal information

#### 16.1 Data sheet status

Document status <sup>[1][2]</sup>	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <a href="http://www.nxp.com">http://www.nxp.com</a>.

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